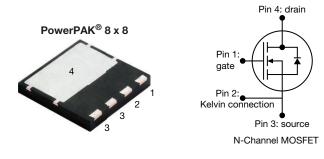
Vishay Siliconix

E Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.087			
Q _g max. (nC)	135				
Q _{gs} (nC)	17				
Q _{gd} (nC)	45				
Configuration	Single				

FEATURES

- Completely lead (Pb)-free device
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- · Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and halogen-free	SiHH27N60EF-T1-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-source voltage	V _{DS}	600	V			
Gate-source voltage	V _{GS}	± 30	v			
Continuous drain current (T _J = 150 °C)	V_{GS} at 10 V $T_C = 25 \degree C$ $T_C = 100 \degree C$	Ι _D	29			
	$T_{\rm C} = 100 ^{\circ}{\rm C}$		18	А		
Pulsed drain current ^a	I _{DM}	73				
Linear derating factor		1.6	W/°C			
Single pulse avalanche energy ^b	E _{AS}	353	mJ			
Maximum power dissipation	PD	202	W			
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C		
Drain-source voltage slope	T _J = 125 °C	dV/dt	100	V/ns		
Reverse diode dV/dt ^c		uv/ut	11	v/ns		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_a = 25 Ω , I_{AS} = 5 A

c. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C

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THERMAL RESISTANCE RATI			I			1		
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	38		50		°C/W		
Maximum junction-to-case (drain)	R _{thJC}	0.48 0.62				0,11		
SPECIFICATIONS (T _J = 25 °C, u	nless otherwis	se noted)						
PARAMETER	SYMBOL	-		ONS	MIN.	TYP.	MAX.	UNI
Static	OTMEDE	120		0110	winte.		10177.	
Drain-source breakdown voltage	V _{DS}	Vec	= 0 V, I _D = 2	50 µA	600	-	-	v
V_{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$		e to 25 °C, I _l		-	0.55	-	V/°
Gate-source threshold voltage (N)	V _{GS(th)}		= V _{GS} , I _D = 2	-	2.0	-	4.0	V
	• GS(III)		$V_{GS} = \pm 20$ \	•	-	-	± 100	n A
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30$ \		-	-	± 1	μA
			= 480 V, V _{GS}		_	-	1	μA
Zero gate voltage drain current	I _{DSS}			T _J = 125 °C	-	-	500	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V		= 13.5 A	-	0.087	0.100	Ω
Forward transconductance	9 _{fs}	V _{DS} =	= 30 V, I _D = 1		-	9.6	-	S
Dynamic	0.0							
Input capacitance	C _{iss}		$V_{ab} = 0.V$		-	2609	-	
Output capacitance	C _{oss}	1	V _{GS} = 0 V, V _{DS} = 100 V,		-	125	-	
Reverse transfer capacitance	C _{rss}	f = 1 MHz V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	5	-	pF	
Effective output capacitance, energy related ^a	C _{o(er)}			-	86	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	449	-		
Total gate charge	Qq				-	90	135	
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_{D} = 13.5 \text{ A}, V_{DS} = 480 \text{ V}$		-	17	-	nC	
Gate-drain charge	Q _{gd}	1			-	45	-	1
Turn-on delay time	t _{d(on)}		•		-	28	56	
Rise time	t _r	V _{DD} =	480 V, I _D = ⁻	13.5 A,	-	63	95	
Turn-off delay time	t _{d(off)}		= 10 V, R _g =		-	101	152	ns
Fall time	t _f				-	59	89	1
Gate input resistance	Rg	f = 1 MHz		0.3	0.6	1.2	Ω	
Drain-Source Body Diode Characteristic	s							
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	29	А	
Pulsed diode forward current	I _{SM}			-	-	73		
Diode forward voltage	V _{SD}	T _J = 25 °C	, I _S = 13.5 A	$V_{GS} = 0 V$	-	0.9	1.2	V
Reverse recovery time	t _{rr}		<u>.</u>		-	144	288	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 13.5 \text{ A},$ dl/dt = 100 A/µs, V _R = 25 V		-	0.9	1.8	μ	
Reverse recovery current	I _{RRM}			-	12	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDS



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

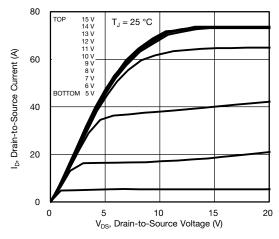


Fig. 1 - Typical Output Characteristics

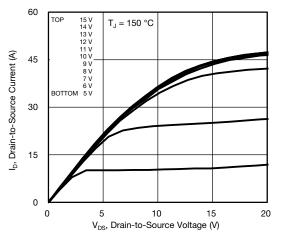


Fig. 2 - Typical Output Characteristics

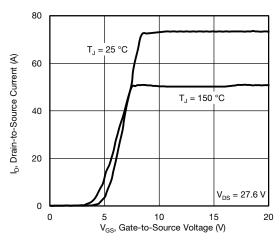


Fig. 3 - Typical Transfer Characteristics

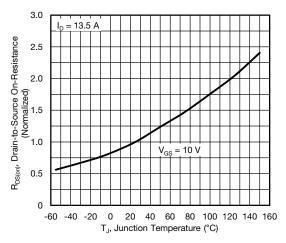


Fig. 4 - Normalized On-Resistance vs. Temperature

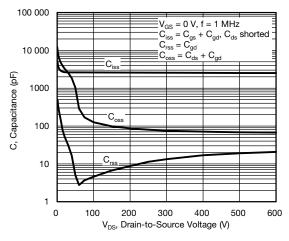


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

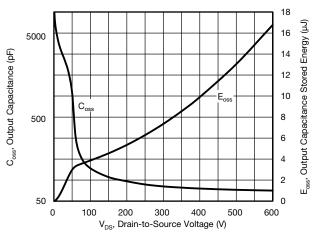


Fig. 6 - C_{OSS} and E_{OSS} vs. V_{DS}

S23-0653-Rev. C, 21-Aug-2023

3 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 91985

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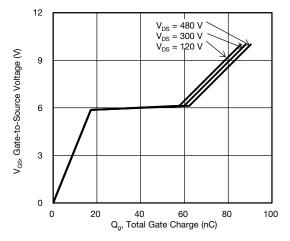


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

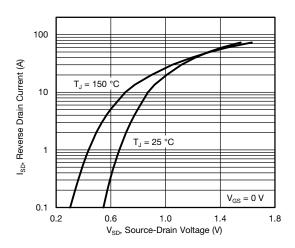
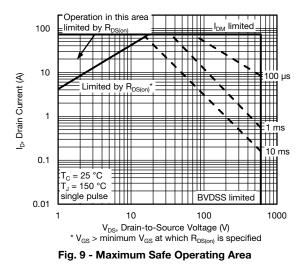


Fig. 8 - Typical Source-Drain Diode Forward Voltage



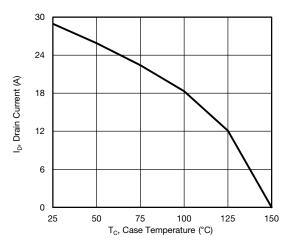


Fig. 10 - Maximum Drain Current vs. Case Temperature

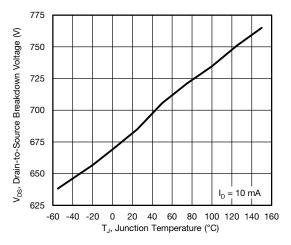
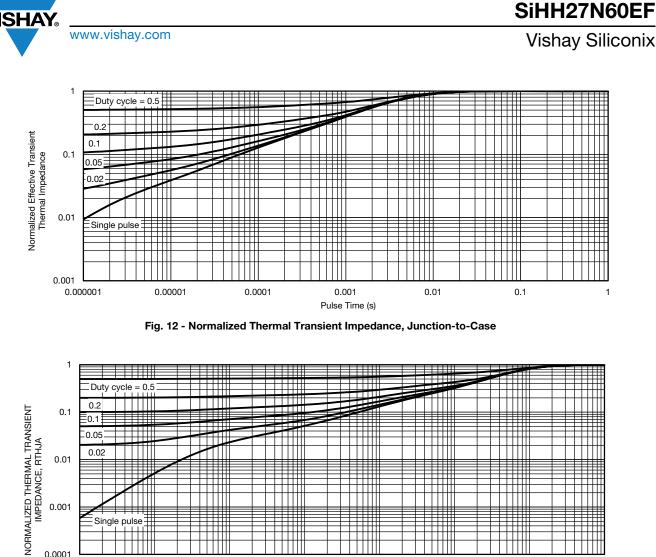


Fig. 11 - Temperature vs. Drain-to-Source Voltage



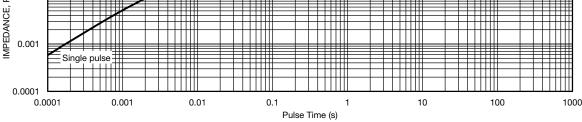


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

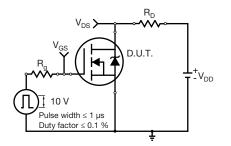


Fig. 14 - Switching Time Test Circuit

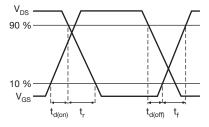


Fig. 15 - Switching Time Waveforms



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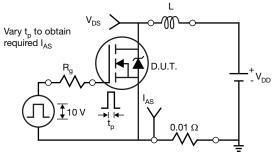


Fig. 16 - Unclamped Inductive Test Circuit

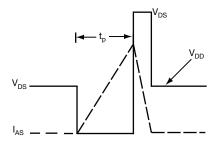


Fig. 17 - Unclamped Inductive Waveforms

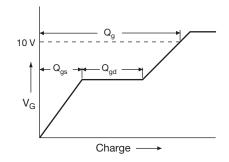


Fig. 18 - Basic Gate Charge Waveform

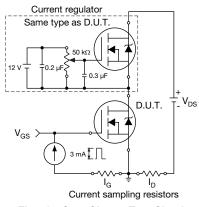
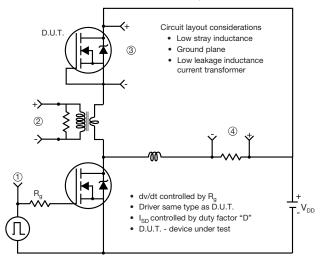


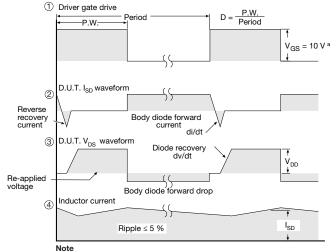
Fig. 19 - Gate Charge Test Circuit

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Peak Diode Recovery dv/dt Test Circuit





a. $V_{GS} = 5$ V for logic level devices

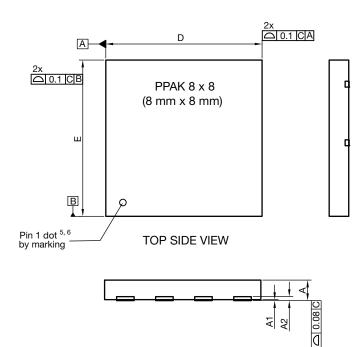
Fig. 20 - For N-Channel

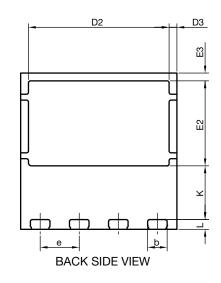
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PowerPAK[®] 8 x 8 Case Outline





DIM		MILLIMETERS		INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.95	1.00	1.05	0.037	0.039	0.041	
A1	0.00	-	0.05	0.000	-	0.002	
A2		020 ref.		0.008 ref.			
b	0.95	1.00	1.05	0.037	0.039	0.041	
D	7.90	8.00	8.10	0.311	0.315	0.319	
D2	7.10	7.20	7.30	0.280	0.283	0.287	
D3		0.40 BSC		0.016 BSC			
е		2.00 BSC		0.079 BSC			
E	7.90	8.00	8.10	0.311	0.315	0.319	
E2	4.30	4.35	4.40	0.169	0.171	0.173	
E3		0.40 BSC		0.016 BSC			
К	2.75 BSC		0.108 BSC				
L	0.45	0.50	0.55	0.018	0.020	0.022	
N ⁽³⁾	8			8			

Notes

⁽¹⁾ Use millimeters as the primary measurement

⁽²⁾ Dimensioning and tolerances conform to ASME Y14.5 M - 1994

⁽³⁾ N is the number of terminals

⁽⁴⁾ The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body

⁽⁵⁾ Exact shape and size of this feature is optional

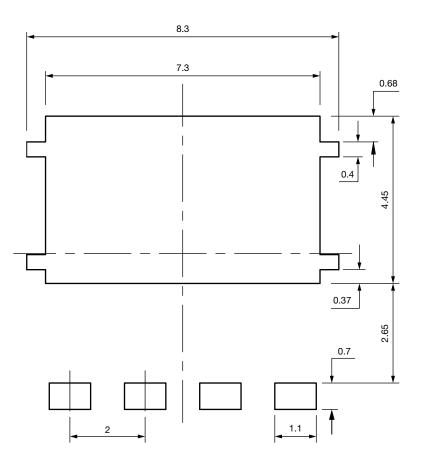
ECN: E20-0518-Rev. B, 28-Sep-2020 DWG: 6041

Revision: 28-Sep-2020



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Recommended Minimum PADs for PowerPAK[®] 8 mm x 8 mm



Dimensions in millimeters

Document Number: 68441



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